



Product Summary (@T_A = +25°C)

V _{RRM} (V)	lo (mA)	V _{F MAX} (mV)	Ι_{R MAX} (μΑ)
@1mA		@1mA	@1V
4	80	310	10

Description

The RF Schottky diode SDR08C04LP3 is with an integrated guard ring on-chip for overvoltage protection. The low barrier height, low-forward voltage and low junction capacitance make SDR08C04LP3 a suitable choice for mixer and detector functions in applications. Encapsulated in the ultra-small X3-DFN0603-2 with footprint of 0.18mm² and ultralow package profile, this device is designed for saving PCB space in portable electronic devices.

Applications

For mixers and detectors in:

- Low barrier diodes for detectors up to GHz
- Radar systems and modules
- For high-speed applications
- Almost zero bias detector diodes

ULTRA-SMALL SURFACE-MOUNT SCHOTTKY DIODE

Features and Benefits

- Ultra-Small Leadless Surface-Mount Package (0.6mm x 0.3mm)
- Very Low Capacity
- Low-Forward Voltage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: X3-DFN0603-2
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish Matte Tin Finish over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 3
- Weight: 0.2mg (Approximate)

X3-DFN0603-2



Ordering Information (Note 4)

Part Number	Paakaga	Pac	king
Part Number	Package	Qty.	Carrier
SDR08C04LP3-7B	X3-DFN0603-2	10,000	Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

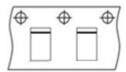
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



C4 = Product Type Marking Code Bar Denotes Cathode Side





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	Vrrm Vrwm Vr	4	V
Forward Current	lo	80	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Power Dissipation (Note 5)	PD	100 (T _C ≤ +80°C)	mW
Typical Thermal Resistance Junction to Case (Note 5)	Rejc	700 (T _C = +80°C)	°C/W
Operating and Storage Temperature Range (Note 6)	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

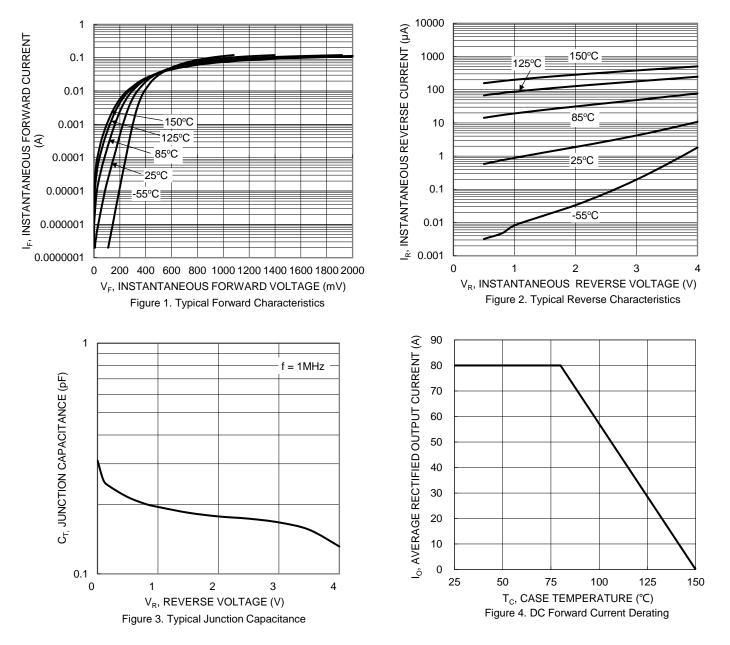
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Breakdown Voltage	VBR	4	—	_	V	I _R = 1mA
Forward Voltage	VF	_	230 340	310 410	mV	IF = 1mA IF = 10mA
Leakage Current (Note 7)	I _R		_	10	μA	V _R = 1V
Reverse Recovery Time	trr	_	1.1	_	ns	$I_F = 10mA$, $I_R = 10mA$, $I_{RR} = 1mA$
Differential Forward Resistance (Note 8)	RF	_	6.5	_	Ω	IF = 10mA/50mA
Total Capacitance	CT	_	0.31	_	pF	$V_R = 0 V_{DC}$, f = 1MHz

5. Part mounted on FR-4 PC board with Diodes Incorporated's recommended pad layout, which can be found on our website at Notes: http://www.diodes.com/package-outlines.html. 6. The heat generated must be less than the thermal conductivity from junction to case: $dP_D/dT_J < 1/R_{BJC}$. 7. Short duration pulse test used to minimize self-heating effect.

8. $R_F = (V_F (50mA) - V_F (10mA)) / (50mA - 10mA).$



SDR08C04LP3



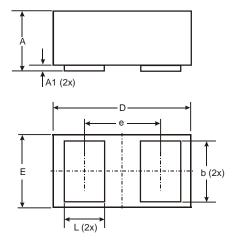


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



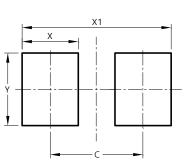
X3-DFN0603-2



X3-DFN0603-2					
Dim	Min	Max	Тур		
Α	0.27	0.35	0.30		
A1	0.00	0.03	0.02		
b	0.19	0.29	0.24		
D	0.595	0.645	0.62		
ш	0.295	0.345	0.32		
e	-	-	0.355		
1	0.14	0.24	0.19		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.380
Х	0.230
X1	0.610
Y	0 300



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